Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	11366	257/81,99,177-181,584,625,675,688,689, 704-707,712,722,796.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:07
L2	5243	1 and (slug ((heat thermal) near (sink spreader dissipat$3)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:45
L3	1130	2 and ((cavity recess groove open$3 hols$1) with (chip die))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:12
L4	1020	2 and ((cavity reccess groove open$3 hols$1) with (chip die))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:13
L5	1315	2 and ((cavity reccess groove open$3 hole$1) with (chip die))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:13
L6	123	2 and ((cavity reccess groove open$3 hole$1) with (chip die) with thick$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:33
L7	419	2 and ((cavity reccess groove open$3 hole$1) same (chip die) same thick$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:38
L8	2	7 and ((downset near leg$1) same (depth thick$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:37
L9	2	7 and (downset near leg$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:47

L10	469	2 and ((cavity reccess groove open$3 hole$1) same (chip die) same (depth thick$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:45
L11	145	10 and (corner$1 notch$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:46
L12	227823	(slug ((heat thermal) near (sink spreader dissipat$3)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 13:27
L13	5725	12 and ((cavity reccess groove open$3 hole$1) same (chip die) same (depth thick$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:46
L14	1827	13 and (corner$1 notch$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:46
L15	6078	12 and ((cavity recess groove open$3 hole$1) same (chip die) same (depth thick$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:52
L16	1934	15 and (corner$1 notch$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:56
L17	3	16 and (downset near leg$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:47
L18	24	16 and downset	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:56

L19	13	15 and ((corner$1 notch$2) same downset)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:53
L20	24701	12 and ((cavity recess groove open$3 hole$1) and (chip die) and (depth thick$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:54
L21	23	20 and ((corner$1 notch$2) same downset)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:55
L22	69790	((cavity recess groove open$3 hole$1) same (chip die) same (depth thick$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 13:21
L23	17	22 and ((corner$1 notch$2) same downset)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 12:55
L24	18007	22 and (corner$1 notch$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 13:22
L25	35	24 and downset	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 13:22
L26	6418	438/22,24,117,122-127.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 13:15
L27	4643	26 and (cavity recess groove open$3 hole$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/10/05 13:22

L28	917	27 and (corner$1 notch$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/05 13:22
L29	19	28 and downset	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/05 13:23
L30	9	("4748538" | "5949137" | "6191360" | "6271058" | "6462410" | "6483169" | "6512675" | "6525420" | "6538320").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/10/05 13:24
L31	0	(slug ((heat thermal) near (sink spreader dissipat$3))) AND (rectangular NEAR shape) AND surface$1 AND (notch$2 corner$1) AND (three NEAR downset NEAR leg$1) AND (cavity recess$2 groove open$3 hole$1) AND (chip die) AND (depth thick$4).CLM.	US-PGPUB; USPAT	OR	ON	2005/10/05 13:31
L32	0	(slug ((heat thermal) near (sink spreader dissipat$3))) AND surface$1 AND (notch$2 corner$1) AND (three NEAR downset NEAR leg$1) AND (cavity recess$2 groove open$3 hole$1) AND (chip die) AND (depth thick$4).CLM.	US-PGPUB; USPAT	OR	ON	2005/10/05 13:31
L33	0	(slug ((heat thermal) near (sink spreader dissipat$3))) AND (rectangular NEAR shape) AND surface$1 AND (notch$2 corner$1) AND (three NEAR downset) AND (cavity recess$2 groove open$3 hole$1) AND (chip die) AND (depth thick$4).CLM.	US-PGPUB; USPAT	OR	ON	2005/10/05 13:32